

UDF012N15

Preliminary

0.12A, 150V N-CHANNEL DEPLETION-MODE POWER MOSFET

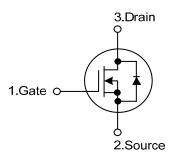
DESCRIPTION

The UTC **UDF012N15** is an N-channel power MOSFET using UTC's advanced technology to provide the customers with high switching speed.

FEATURES

- * $R_{DS(ON)} \le 35 \Omega @ V_{GS}=0V, I_D=100mA$
- * Depletion Mode (Normally On)
- * Proprietary Advanced Planar Technology
- * Rugged Polysilicon Gate Cell Structure
- * Fast Switching Speed

SYMBOL

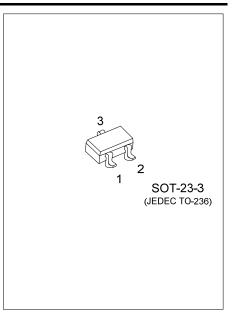


ORDERING INFORMATION

Ordering Number		Deekege	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
UDF012N15L-AE2-R	UDF012N15G-AE2-R	SOT-23-3	G	S	D	Tape Reel	
Note: Pin Assignment: G: Gate S: Source D: Drain							
UDF012N15G-AE2-R	(1) R: Tape Re (2) AE2: SOT- (3) G: Haloger	23-3	d Lead Fro	ee, L: Lea	ad Free		

MARKING





■ ABSOLUTE MAXIMUM RATINGS (T_A=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage (Note 2)		V _{DSX}	150	V
Drain-Gate Voltage (Note 2)		V _{DGX}	150	V
Gate-Source Voltage		V _{GSS}	±30	V
Drain Current	Continuous	I _D	0.12	А
	Pulsed	I _{DM}	0.24	А
Power Dissipation		PD	0.3	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. T_J=+25°C~+150°C.

THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ _{JA}	416	°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T_A=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSX}	I _D =250μA, V _{GS} =-30V	150			V
Drain-Source Leakage Current		I _{D(OFF)}	V _{DS} =150V, V _{GS} =-30V			1	μA
Gate-Source Leakage Current	Forward	- I _{GSS}	V _{GS} =+30V, V _{DS} =0V			+100	nA
	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate to Source Cut Off Voltage		V _{GS(OFF)}	V _{DS} =20V, Ι _D =8.0μΑ	-13		-21	V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =25V, V _{GS} =0V	120			mA
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =0V, I _D =100mA			35	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C _{ISS}			1.4		рF
Output Capacitance		Coss	V _{GS} =-15V, V _{DS} =25V, f=1.0MHz		5.4		рF
Reverse Transfer Capacitance		C _{RSS}			2.3		рF
SWITCHING PARAMETERS							
Turn-ON Delay Time		t _{D(ON)}			60		ns
Rise Time		t _R	V _{GS} =-15~0V, V _{DD} =30V,		32		ns
Turn-OFF Delay Time		t _{D(OFF)}	I _D =120mA, R _G =20Ω		35		ns
Fall-Time		t _F			42		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Drain-Source Diode Forward Voltage		V _{SD}	I _{SD} =120mA, V _{GS} =-10V			1.4	V

Notes: 1. Repetitive rating, pulse width limited by maximum junction temperature.

2. Pulse width \leq 380µs; duty cycle \leq 2%.

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